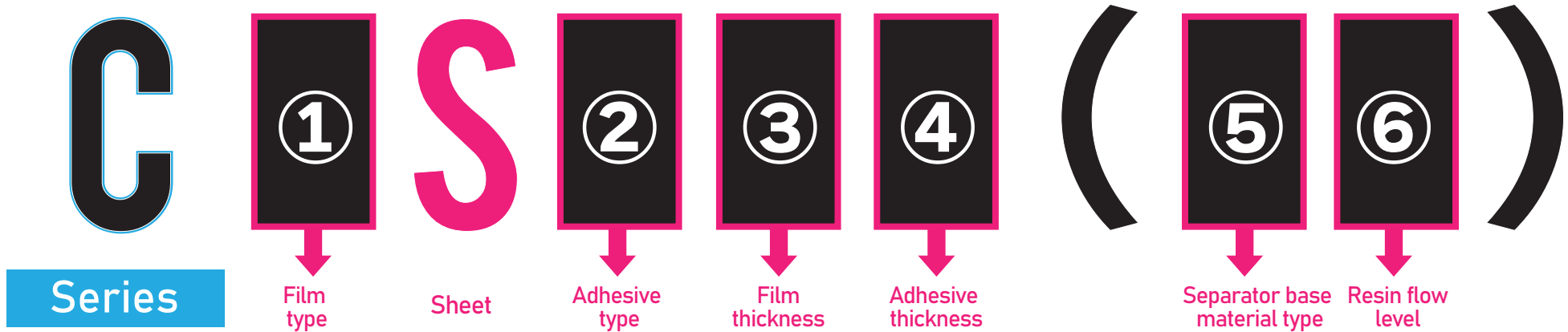


NIKAFLEX® Coverlay for Flexible Printed Circuits

C-series

C-series code meaning



Series	① Film type	② Adhesive type	③ Film thickness	④ Adhesive thickness
C	I : General PI N : Low elasticity PI K : High dimension stability PI	A : Halogen contained, anti-migration E : General purpose, halogen free F : Halogen free, anti-migration G : Halogen free, anti-migration, high Tg V : General purpose, halogen contained Y : Halogen free, low Dk/Df	5 ~ 50μm	12 ~ 35μm
			⑤ Separator base material type	⑥ Resin flow level
			※The supplementary information of separator base material type and resin flow level is showed in brackets.	